

Electronic Patent Application Fee Transmittal

Application Number:	10568410			
Filing Date:	14-Feb-2006			
Title of Invention:	MOLDING COMPOUND			
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Filer:	Marvin Jay Spivak/April Foubare			
Attorney Docket Number:	285619US0PCT			
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Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
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Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
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Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
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Request for continued examination	1801	1	810	810
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